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ON Semiconductor®



ASM3P2590A

Peak EMI Reducing Solution

Features

- Generates a 1X low EMI optimized clock signal at the output.
- Integrated loop filter components.
- Operates with a 3.3 / 2.5V Supply.
- Operating current less than 5mA.
- CMOS design.
- Input frequency range

60MHz to 120MHz for 2.5V

- 60MHz to 120MHz for 3.3V
- Frequency deviation: ±0.75% (Typ) @ 85MHz Output frequency.
- Available in 6L-TSOP (6L-TSOT-23) Package.

Product Description

The ASM3P2590A is a versatile spread spectrum frequency modulator designed specifically for a wide range of clock frequencies. The ASM3P2590A reduces electromagnetic interference (EMI) at the clock source, allowing system wide reduction of EMI of all clock dependent signals. The ASM3P2590A allows significant system cost savings by reducing the number of circuit board layers, ferrite beads and shielding that are traditionally required to pass EMI regulations.

The ASM3P2590A uses the most efficient and optimized modulation profile approved by the FCC and is implemented by using a proprietary all digital method.

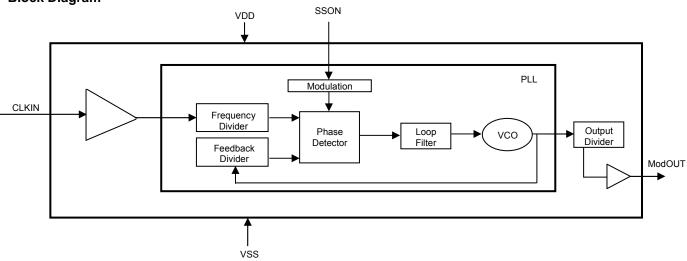
The ASM3P2590A modulates the output of a single PLL in order to "spread" the bandwidth of a synthesized clock, and more importantly, decreases the peak amplitudes of its harmonics. This result in significantly lower system EMI compared to the typical narrow band signal produced by oscillators and most frequency generators. Lowering EMI by increasing a signal's bandwidth is called 'spread spectrum clock generation.'

Applications

The ASM3P2590A is targeted towards all portable devices with very low power requirements like MP3 players, MFP, LCD Panel Module and digital still cameras.

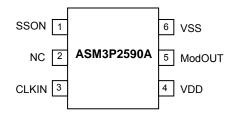
Key Specifications

Description	Specification
Supply voltages	VDD = 3.3V / 2.5V
Cycle-to-Cycle Jitter	±360pS (Typ)
Output Duty Cycle	45/55%
Modulation Rate Equation	F _{IN} /2560
Frequency Deviation	±0.75% (Typ) @ 85MHz Output



Block Diagram

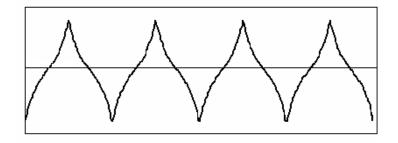
Pin Configuration (6L-TSOP Package)



Pin Description

_	oonption		
Pin#	Pin Name	Туре	Description
1	SSON	I	When SSON is HIGH, the spread spectrum is enabled and when LOW, it turns off the spread spectrum. Connect the pin to ground when Spread Spectrum feature is not required.
2	NC	-	No Connect.
3	CLKIN	I	Clock Input.
4	VDD	Р	Power supply for the entire chip.
5	ModOUT	0	Spread spectrum clock output.
6	VSS	Р	Ground connection.

Modulation Profile



Specifications

Desc	ription	Specification
	For 2.5V Supply	60MHz < CLKIN < 120MHz
Frequency Range	For 3.3V Supply	60MHz < CLKIN < 120MHz
Modulation Equatio	n	F _{IN} /2560
Frequency Deviation	n	±0.75% (Typ) @ 85MHz Output

Absolute Maximum Ratings

Parameter	Rating	Unit
Voltage on any pin with respect to Ground	-0.5 to +4.6	V
Storage temperature	-65 to +125	C
Operating temperature	-40 to +85	C
Max. Soldering Temperature (10 sec)	260	C
Junction Temperature	150	C
Static Discharge Voltage (As per JEDEC STD22- A114-B)	2	КV
	Voltage on any pin with respect to Ground Storage temperature Operating temperature Max. Soldering Temperature (10 sec) Junction Temperature Static Discharge Voltage	Voltage on any pin with respect to Ground-0.5 to +4.6Storage temperature-65 to +125Operating temperature-40 to +85Max. Soldering Temperature (10 sec)260Junction Temperature150Static Discharge Voltage2

Operating Conditions

Parameter	Description	Min	Max	Unit
VDD	Supply Voltage	2.375	3.6	V
T _A	Operating Temperature (Ambient Temperature)	0	+70	C
CL	Load Capacitance		15	pF
CIN	Input Capacitance		7	рF

DC Electrical Characteristics for 2.5V Supply

Symbol	Parameter	Min	Тур	Мах	Unit
VIL	Input low voltage	VSS-0.3		0.8	V
V _{IH}	Input high voltage	2.0		VDD+0.3	V
I _{IL}	Input low current			-35	μA
IIH	Input high current			35	μA
V _{OL}	Output low voltage (VDD = $2.5V$, $I_{OL} = 8mA$)			0.6	V
V _{OH}	Output high voltage (VDD = 2.5V, I _{OH} = 8mA)	1.8			V
IDD	Static supply current ¹		1.8		mA
Icc	Dynamic supply current (2.5V, 85MHz and no load)		4.0		mA
VDD	Operating voltage	2.375	2.5	2.625	V
t _{ON}	Power-up time (first locked cycle after power-up)			5	mS
Z _{OUT}	Output impedance		50		Ω
Note: 1. CLK	N pin is pulled low.				

Symbol	Pa	Min	Тур	Max	Unit	
CLKIN	Input frequency		60		120	MHz
ModOUT	Output frequency		60		120	MHz
f		Input Frequency = 60MHz		±0.85		0/
f _d	Frequency Deviation	Input Frequency = 120MHz		±0.60		%
t _{LH} ¹	Output rise time (measu	0.7	1.8	2.6	nS	
t _{HL} 1	Output fall time (measu	0.4	0.9	1.1	nS	
t _{JC}	Jitter (Cycle-to-cycle)		±360		pS	
t _D	Output duty cycle	45	50	55	%	
Note: 1. t_{LH} and t_{HL}	are measured into a capacitive lo	ad of 15pF.				

AC Electrical Characteristics for 2.5V Supply

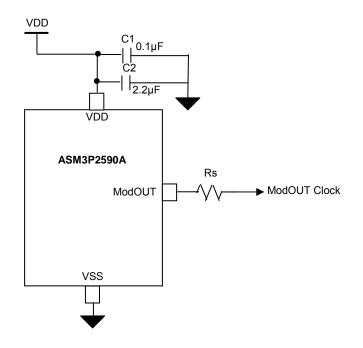
DC Electrical Characteristics for 3.3V Supply

Symbol	Parameter	Min	Тур	Max	Unit
VIL	Input low voltage	VSS-0.3		0.8	V
VIH	Input high voltage	2.0		VDD+0.3	V
IIL	Input low current			-35	μA
I _{IH}	Input high current			35	μA
V _{OL}	Output low voltage (VDD = 3.3V, I _{OL} = 8mA)			0.4	V
V _{OH}	Output high voltage (VDD = 3.3V, I _{OH} = 8mA)	2.5			V
IDD	Static supply current ¹		2.2		mA
I _{CC}	Dynamic supply current (3.3V, 85MHz and no load)		4.5		mA
VDD	Operating voltage	3.0	3.3	3.6	V
t _{ON}	Power-up time (first locked cycle after power-up)			5	mS
Z _{OUT}	Output impedance		45		Ω
Note: 1. CLK	IN pin is pulled low.				

AC Electrical Characteristics for 3.3V Supply

ut frequency tput frequency		60 60		120	MHz
· · · ·	Ι	60			
				120	MHz
augnes Deviction	Input Frequency = 60MHz		±0.85		%
Frequency Deviation Input	Input Frequency = 120MHz		±0.60		70
Output rise time (measured from 0.8 to 2.0V)		0.5	1.2	1.8	nS
Output fall time (measured at 2.0V to 0.8V)		0.3	0.8	1.1	nS
Jitter (cycle-to-cycle)			±360		pS
Output duty cycle			50	55	%
t	put fall time (measur er (cycle-to-cycle) put duty cycle	put rise time (measured from 0.8 to 2.0V) put fall time (measured at 2.0V to 0.8V) er (cycle-to-cycle)	put rise time (measured from 0.8 to 2.0V)0.5put fall time (measured at 2.0V to 0.8V)0.3er (cycle-to-cycle)45	put rise time (measured from 0.8 to 2.0V) 0.5 1.2 put fall time (measured at 2.0V to 0.8V) 0.3 0.8 er (cycle-to-cycle) ±360 put duty cycle 45 50	put rise time (measured from 0.8 to 2.0V) 0.5 1.2 1.8 put fall time (measured at 2.0V to 0.8V) 0.3 0.8 1.1 er (cycle-to-cycle) ±360 ±360 put duty cycle 45 50 55

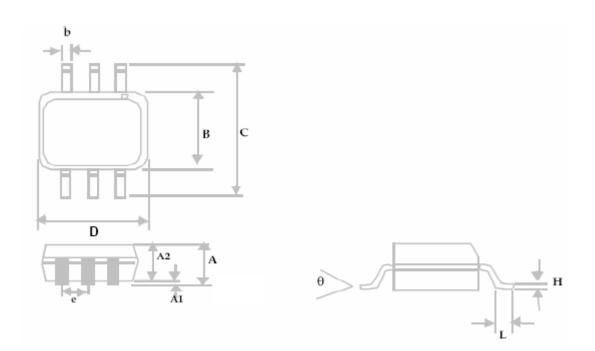
Typical Application Schematic



ASM3P2590A

Package Information

6L-TSOP Package



	Dimensions				
Symbol	Inches		Millim	neters	
	Min	Max	Min	Max	
А		0.04		1.00	
A1	0.00	0.004	0.00	0.10	
A2	0.033	0.036	0.84	0.90	
b	0.012	0.02	0.30	0.50	
Н	0.005 BSC		0.127 BSC		
D	0.114 BSC		2.90 BSC		
В	0.06 BSC		1.60 BSC		
е	0.0374 BSC		0.950 BSC		
С	0.11 BSC		2.80	BSC	
L	0.0118	0.02	0.30	0.50	
θ	0°	4°	0°	4°	

ASM3P2590A

Ordering Information

Part Number	Marking	Package Type	Temperature
P3P2590AF-06OR	Y4L	6L-TSOP (6L-TSOT-23), TAPE & REEL, Pb Free	0℃ to +70℃

A "microdot" placed at the end of last row of marking or just below the last row toward the center of package indicates Pb-free.

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